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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	24MHz
Connectivity	I ² C, IrDA, LINbus, Microwire, SmartCard, SPI, SSP, UART/USART
Peripherals	Brown-out Detect/Reset, CapSense, LCD, LVD, POR, PWM, WDT
Number of I/O	51
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.71V ~ 5.5V
Data Converters	A/D 16x12b SAR; 2xIDAC
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c4126azi-m475

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Pinouts

The following is the pin list for the PSoC 4100M. This shows the power supply and port pins (for example, P0.0 is Pin 0 of Port 0).

68-QFN		64-TQFP		48-TQFP		44-TQFP	
Pin	Name	Pin	Name	Pin	Name	Pin	Name
42	P0.0	39	P0.0	28	P0.0	24	P0.0
43	P0.1	40	P0.1	29	P0.1	25	P0.1
44	P0.2	41	P0.2	30	P0.2	26	P0.2
45	P0.3	42	P0.3	31	P0.3	27	P0.3
46	P0.4	43	P0.4	32	P0.4	28	P0.4
47	P0.5	44	P0.5	33	P0.5	29	P0.5
48	P0.6	45	P0.6	34	P0.6	30	P0.6
49	P0.7	46	P0.7	35	P0.7	31	P0.7
50	XRES	47	XRES	36	XRES	32	XRES
51	VCCD	48	VCCD	37	VCCD	33	VCCD
52	VSSD	49	VSSD	38	VSSD	DN	VSSD
53	VDDD	50	VDDD	39	VDDD	34	VDDD
				40	VDDA	35	VDDA
54	P5.0	51	P5.0				
55	P5.1	52	P5.1				
56	P5.2	53	P5.2				
57	P5.3	54	P5.3				
58	P5.4						
59	P5.5	55	P5.5				
60	VDDA	56	VDDA	40	VDDA	35	VDDA
61	VSSA	57	VSSA	41	VSSA	36	VSSA
62	P1.0	58	P1.0	42	P1.0	37	P1.0
63	P1.1	59	P1.1	43	P1.1	38	P1.1
64	P1.2	60	P1.2	44	P1.2	39	P1.2
65	P1.3	61	P1.3	45	P1.3	40	P1.3
66	P1.4	62	P1.4	46	P1.4	41	P1.4
67	P1.5	63	P1.5	47	P1.5	42	P1.5
68	P1.6	64	P1.6	48	P1.6	43	P1.6
1	P1.7/VREF	1	P1.7/VREF	1	P1.7/VREF	44	P1.7/VREF
						1	VSSD
2	P2.0	2	P2.0	2	P2.0	2	P2.0
3	P2.1	3	P2.1	3	P2.1	3	P2.1
4	P2.2	4	P2.2	4	P2.2	4	P2.2
5	P2.3	5	P2.3	5	P2.3	5	P2.3
6	P2.4	6	P2.4	6	P2.4	6	P2.4
7	P2.5	7	P2.5	7	P2.5	7	P2.5

Each of the pins shown in the previous table can have multiple programmable functions as shown in the following table. Column headings refer to Analog and Alternate pin functions:

Port/Pin	Analog	Alt. Function 1	Alt. Function 2	Alt. Function 3	Alt. Function 4	Alt. Function 5
P0.0	lpcomp.in_p[0]					scb[0].spi_select1:0
P0.1	lpcomp.in_n[0]					scb[0].spi_select2:0
P0.2	lpcomp.in_p[1]					scb[0].spi_select3:0
P0.3	lpcomp.in_n[1]					
P0.4	wco_in		scb[1].uart_rx:0		scb[1].i2c_scl:0	scb[1].spi_mosi:1
P0.5	wco_out		scb[1].uart_tx:0		scb[1].i2c_sda:0	scb[1].spi_miso:1
P0.6		ext_clk:0	scb[1].uart_cts:0			scb[1].spi_clk:1
P0.7			scb[1].uart_rts:0		wakeup	scb[1].spi_select0:1
P5.0	ctb1.oa0.inp	tcpwm.line[4]:2	scb[2].uart_rx:0		scb[2].i2c_scl:0	scb[2].spi_mosi:0
P5.1	ctb1.oa0.inm	tcpwm.line_compl[4]:2	scb[2].uart_tx:0		scb[2].i2c_sda:0	scb[2].spi_miso:0
P5.2	ctb1.oa0.out	tcpwm.line[5]:2	scb[2].uart_cts:0		lpcomp.comp[0]:1	scb[2].spi_clk:0
P5.3	ctb1.oa1.out	tcpwm.line_compl[5]:2	scb[2].uart_rts:0		lpcomp.comp[1]:1	scb[2].spi_select0:0
P5.4	ctb1.oa1.inm	tcpwm.line[6]:2				scb[2].spi_select1:0
P5.5	ctb1.oa1.inp	tcpwm.line_compl[6]:2				scb[2].spi_select2:0
P5.6	ctb1.oa0.inp_alt	tcpwm.line[7]:0				scb[2].spi_select3:0
P5.7	ctb1.oa1.inp_alt	tcpwm.line_compl[7]:0				
P1.0	ctb0.oa0.inp	tcpwm.line[2]:1	scb[0].uart_rx:1		scb[0].i2c_scl:0	scb[0].spi_mosi:1
P1.1	ctb0.oa0.inm	tcpwm.line_compl[2]:1	scb[0].uart_tx:1		scb[0].i2c_sda:0	scb[0].spi_miso:1
P1.2	ctb0.oa0.out	tcpwm.line[3]:1	scb[0].uart_cts:1			scb[0].spi_clk:1
P1.3	ctb0.oa1.out	tcpwm.line_compl[3]:1	scb[0].uart_rts:1			scb[0].spi_select0:1
P1.4	ctb0.oa1.inm	tcpwm.line[6]:1				scb[0].spi_select1:1
P1.5	ctb0.oa1.inp	tcpwm.line_compl[6]:1				scb[0].spi_select2:1
P1.6	ctb0.oa0.inp_alt	tcpwm.line[7]:1				scb[0].spi_select3:1
P1.7	ctb0.oa1.inp_alt	tcpwm.line_compl[7]:1				
P2.0	sarmux.0	tcpwm.line[4]:1			scb[1].i2c_scl:1	scb[1].spi_mosi:2
P2.1	sarmux.1	tcpwm.line_compl[4]:1			scb[1].i2c_sda:1	scb[1].spi_miso:2
P2.2	sarmux.2	tcpwm.line[5]:1				scb[1].spi_clk:2
P2.3	sarmux.3	tcpwm.line_compl[5]:1				scb[1].spi_select0:2
P2.4	sarmux.4	tcpwm.line[0]:1				scb[1].spi_select1:1
P2.5	sarmux.5	tcpwm.line_compl[0]:1				scb[1].spi_select2:1
P2.6	sarmux.6	tcpwm.line[1]:1				scb[1].spi_select3:1
P2.7	sarmux.7	tcpwm.line_compl[1]:1				scb[3].spi_select0:1

Port/Pin	Analog	Alt. Function 1	Alt. Function 2	Alt. Function 3	Alt. Function 4	Alt. Function 5
P6.0		tcpwm.line[4]:0	scb[3].uart_rx:0		scb[3].i2c_scl:0	scb[3].spi_mosi:0
P6.1		tcpwm.line_compl[4]:0	scb[3].uart_tx:0		scb[3].i2c_sda:0	scb[3].spi_miso:0
P6.2		tcpwm.line[5]:0	scb[3].uart_cts:0			scb[3].spi_clk:0
P6.3		tcpwm.line_compl[5]:0	scb[3].uart_rts:0			scb[3].spi_select0:0
P6.4		tcpwm.line[6]:0				scb[3].spi_select1:0
P6.5		tcpwm.line_compl[6]:0				scb[3].spi_select2:0
P3.0		tcpwm.line[0]:0	scb[1].uart_rx:1		scb[1].i2c_scl:2	scb[1].spi_mosi:0
P3.1		tcpwm.line_compl[0]:0	scb[1].uart_tx:1		scb[1].i2c_sda:2	scb[1].spi_miso:0
P3.2		tcpwm.line[1]:0	scb[1].uart_cts:1		swd_data	scb[1].spi_clk:0
P3.3		tcpwm.line_compl[1]:0	scb[1].uart_rts:1		swd_clk	scb[1].spi_select0:0
P3.4		tcpwm.line[2]:0				scb[1].spi_select1:0
P3.5		tcpwm.line_compl[2]:0				scb[1].spi_select2:0
P3.6		tcpwm.line[3]:0				scb[1].spi_select3:0
P3.7		tcpwm.line_compl[3]:0				
P4.0			scb[0].uart_rx:0		scb[0].i2c_scl:1	scb[0].spi_mosi:0
P4.1			scb[0].uart_tx:0		scb[0].i2c_sda:1	scb[0].spi_miso:0
P4.2	csd[0].c_mod		scb[0].uart_cts:0		lpcomp.comp[0]:0	scb[0].spi_clk:0
P4.3	csd[0].c_sh_tank		scb[0].uart_rts:0		lpcomp.comp[1]:0	scb[0].spi_select0:0
P4.4						scb[0].spi_select1:2
P4.5						scb[0].spi_select2:2
P4.6						scb[0].spi_select3:2
P4.7						
P7.0		tcpwm.line[0]:2	scb[3].uart_rx:1		scb[3].i2c_scl:1	scb[3].spi_mosi:1
P7.1		tcpwm.line_compl[0]:2	scb[3].uart_tx:1		scb[3].i2c_sda:1	scb[3].spi_miso:1
P7.2		tcpwm.line[1]:2	scb[3].uart_cts:1			scb[3].spi_clk:1

Descriptions of the power pin functions are as follows:

VDDD: Power supply for both analog and digital sections (where there is no V_{DDA} pin).

VDDA: Analog V_{DD} pin where package pins allow; shorted to V_{DDD} otherwise.

VDDIO: I/O pin power domain.

VSSA: Analog ground pin where package pins allow; shorted to VSS otherwise

VSS: Ground pin.

VCCD: Regulated Digital supply (1.8 V $\pm$ 5%).

Port Pins can all be used as LCD Commons, LCD Segment drivers, or CSD sense and shield pins can be connected to AMUXBUS A or B or can all be used as GPIO pins that can be driven by firmware or DSI signals.

Development Support

The PSoC 4100M family has a rich set of documentation, development tools, and online resources to assist you during your development process. Visit www.cypress.com/go/psoc4 to find out more.

Documentation

A suite of documentation supports the PSoC 4100M family to ensure that you can find answers to your questions quickly. This section contains a list of some of the key documents.

Software User Guide: A step-by-step guide for using PSoC Creator. The software user guide shows you how the PSoC Creator build process works in detail, how to use source control with PSoC Creator, and much more.

Component Datasheets: The flexibility of PSoC allows the creation of new peripherals (components) long after the device has gone into production. Component data sheets provide all of the information needed to select and use a particular component, including a functional description, API documentation, example code, and AC/DC specifications.

Application Notes: PSoC application notes discuss a particular application of PSoC in depth; examples include brushless DC motor control and on-chip filtering. Application notes often include example projects in addition to the application note document.

Technical Reference Manual: The Technical Reference Manual (TRM) contains all the technical detail you need to use a PSoC device, including a complete description of all PSoC registers.

Online

In addition to print documentation, the Cypress PSoC forums connect you with fellow PSoC users and experts in PSoC from around the world, 24 hours a day, 7 days a week.

Tools

With industry standard cores, programming, and debugging interfaces, the PSoC 4100M family is part of a development tool ecosystem. Visit us at www.cypress.com/go/psoccreator for the latest information on the revolutionary, easy to use PSoC Creator IDE, supported third party compilers, programmers, debuggers, and development kits.

Table 2. DC Specifications (continued)

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details / Conditions
Deep Sleep Mode, -40 °C to + 60 °C							
SID30	I _{DD25}	I ² C wakeup and WDT on. Regulator Off.	–	1.55	20	μA	V _{DD} = 1.71 to 1.89
SID31	I _{DD26}	I ² C wakeup and WDT on.	–	1.35	15	μA	V _{DD} = 1.8 to 3.6
SID32	I _{DD27}	I ² C wakeup and WDT on.	–	1.5	15	μA	V _{DD} = 3.6 to 5.5
Deep Sleep Mode, +85 °C							
SID33	I _{DD28}	I ² C wakeup and WDT on. Regulator Off.	–	–	60	μA	V _{DD} = 1.71 to 1.89
SID34	I _{DD29}	I ² C wakeup and WDT on.	–	–	45	μA	V _{DD} = 1.8 to 3.6
SID35	I _{DD30}	I ² C wakeup and WDT on.	–	–	30	μA	V _{DD} = 3.6 to 5.5
Deep Sleep Mode, +105 °C							
SID33Q	I _{DD28Q}	I ² C wakeup and WDT on. Regulator Off.	–	–	135	μA	V _{DD} = 1.71 to 1.89
SID34Q	I _{DD29Q}	I ² C wakeup and WDT on.	–	–	180	μA	V _{DD} = 1.8 to 3.6
SID35Q	I _{DD30Q}	I ² C wakeup and WDT on.	–	–	140	μA	V _{DD} = 3.6 to 5.5
Hibernate Mode, -40 °C to + 60 °C							
SID39	I _{DD34}	Regulator Off.	–	150	3000	nA	V _{DD} = 1.71 to 1.89
SID40	I _{DD35}		–	150	1000	nA	V _{DD} = 1.8 to 3.6
SID41	I _{DD36}		–	150	1100	nA	V _{DD} = 3.6 to 5.5
Hibernate Mode, +85 °C							
SID42	I _{DD37}	Regulator Off.	–	–	4500	nA	V _{DD} = 1.71 to 1.89
SID43	I _{DD38}		–	–	3500	nA	V _{DD} = 1.8 to 3.6
SID44	I _{DD39}		–	–	3500	nA	V _{DD} = 3.6 to 5.5
Hibernate Mode, +105 °C							
SID42Q	I _{DD37Q}	Regulator Off.	–	–	19.4	μA	V _{DD} = 1.71 to 1.89
SID43Q	I _{DD38Q}		–	–	17	μA	V _{DD} = 1.8 to 3.6
SID44Q	I _{DD39Q}		–	–	16	μA	V _{DD} = 3.6 to 5.5
Stop Mode, +85 °C							
SID304	I _{DD43A}	Stop Mode current; V _{DD} = 3.6 V	–	35	85	nA	T = -40 °C to +60 °C
SID304A	I _{DD43B}	Stop Mode current; V _{DD} = 3.6 V	–	–	1450	nA	T = +85 °C
Stop Mode, +105 °C							
SID304Q	I _{DD43AQ}	Stop Mode current; V _{DD} = 3.6 V	–	–	5645	nA	
XRES current							
SID307	I _{DD_XR}	Supply current while XRES asserted	–	2	5	mA	

Table 8. Opamp Specifications

(Guaranteed by Characterization) (continued)

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID_DS_18	VOS_LOW_M2	Mode 2, Low current	–	5	–	mV	With trim 25 °C, 0.2 V to V _{DDA} -1.5 V
SID_DS_19	IOUT_HI_M1	Mode 1, High current	–	10	–	mA	Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_20	IOUT_MED_M1	Mode 1, Medium current	–	10	–	mA	Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_21	IOUT_LOW_M1	Mode 1, Low current	–	4	–	mA	Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_22	IOUT_HI_M2	Mode 2, High current	–	1	–	mA	Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_23	IOUT_MED_M2	Mode 2, Medium current	–	1	–	mA	Output is 0.5 V to V _{DDA} -0.5 V
SID_DS_24	IOUT_LOW_M2	Mode 2, Low current	–	0.5	–	mA	Output is 0.5 V to V _{DDA} -0.5 V

Comparator

Table 9. Comparator DC Specifications

Spec ID#	Parameter	Description	Min	Typ	Max	Units	Details/ Conditions
SID85	V _{OFFSET2}	Input offset voltage, Common Mode voltage range from 0 to V _{DD} -1	–	–	±4	mV	
SID85A	V _{OFFSET3}	Input offset voltage. Ultra low-power mode (V _{DDD} ≥ 2.2 V for Temp < 0 °C, V _{DDD} ≥ 1.8 V for Temp > 0 °C).	–	±12	–	mV	
SID86	V _{HYST}	Hysteresis when enabled, Common Mode voltage range from 0 to V _{DD} -1.	–	10	35	mV	Guaranteed by characterization
SID87	V _{ICM1}	Input common mode voltage in normal mode	0	–	V _{DDD} -0.1	V	Modes 1 and 2.
SID247	V _{ICM2}	Input common mode voltage in low power mode	0	–	V _{DDD}	V	
SID247A	V _{ICM3}	Input common mode voltage in ultra low power mode (V _{DDD} ≥ 2.2 V for Temp < 0 °C, V _{DDD} ≥ 1.8 V for Temp > 0 °C)	0	–	V _{DDD} -1.15	V	
SID88	CMRR	Common mode rejection ratio	50	–	–	dB	V _{DDD} ≥ 2.7 V. Guaranteed by characterization
SID88A	CMRR	Common mode rejection ratio	42	–	–	dB	V _{DDD} < 2.7 V. Guaranteed by characterization
SID89	I _{CMP1}	Block current, normal mode	–	–	400	μA	Guaranteed by characterization
SID248	I _{CMP2}	Block current, low power mode	–	–	100	μA	Guaranteed by characterization
SID259	I _{CMP3}	Block current, ultra low power mode (V _{DDD} ≥ 2.2 V for Temp < 0 °C, V _{DDD} ≥ 1.8 V for Temp > 0 °C)	–	6	28	μA	Guaranteed by characterization
SID90	Z _{CMP}	DC input impedance of comparator	35	–	–	MΩ	Guaranteed by characterization

Digital Peripherals

The following specifications apply to the Timer/Counter/PWM peripheral in timer mode.

Timer/Counter/PWM

Table 15. TCPWM Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID.TCPWM.1	ITCPWM1	Block current consumption at 3 MHz	–	–	45	μA	All modes (Timer/Counter/PWM)
SID.TCPWM.2	ITCPWM2	Block current consumption at 12 MHz	–	–	155	μA	All modes (Timer/Counter/PWM)
SID.TCPWM.2A	ITCPWM3	Block current consumption at 48 MHz	–	–	650	μA	All modes (Timer/Counter/PWM)
SID.TCPWM.3	TCPWMFREQ	Operating frequency	–	–	F _c	MHz	F _c max = F _{cpu} . Maximum = 24 MHz
SID.TCPWM.4	TPWMENEXT	Input Trigger Pulse Width for all Trigger Events	2/F _c	–	–	ns	Trigger Events can be Stop, Start, Reload, Count, Capture, or Kill depending on which mode of operation is selected.
SID.TCPWM.5	TPWMEXT	Output Trigger Pulse widths	2/F _c	–	–	ns	Minimum possible width of Overflow, Underflow, and CC (Counter equals Compare value) trigger outputs
SID.TCPWM.5A	TCRES	Resolution of Counter	1/F _c	–	–	ns	Minimum time between successive counts
SID.TCPWM.5B	PWMRES	PWM Resolution	1/F _c	–	–	ns	Minimum pulse width of PWM Output
SID.TCPWM.5C	QRES	Quadrature inputs resolution	1/F _c	–	–	ns	Minimum pulse width between Quadrature phase inputs.

I²C

Table 16. Fixed I²C DC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID149	I _{I2C1}	Block current consumption at 100 kHz	–	–	50	μA	
SID150	I _{I2C2}	Block current consumption at 400 kHz	–	–	135	μA	
SID151	I _{I2C3}	Block current consumption at 1 Mbps	–	–	310	μA	
SID152	I _{I2C4}	I ² C enabled in Deep Sleep mode	–	–	1.4	μA	

Table 17. Fixed I²C AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID153	F _{I2C1}	Bit rate	–	–	1	Mbps	

LCD Direct Drive

Table 18. LCD Direct Drive DC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID154	I _{LCDLOW}	Operating current in low power mode	–	5	–	μA	16 × 4 small segment disp. at 50 Hz
SID155	C _{LCDCAP}	LCD capacitance per segment/common driver	–	500	5000	pF	Guaranteed by Design
SID156	LCD _{OFFSET}	Long-term segment offset	–	20	–	mV	
SID157	I _{LCDOP1}	PWM Mode current. 5-V bias. 24-MHz IMO	–	0.6	–	mA	32 × 4 segments. 50 Hz, 25 °C
SID158	I _{LCDOP2}	PWM Mode current. 3.3-V bias. 24-MHz IMO.	–	0.5	–	mA	32 × 4 segments. 50 Hz, 25 °C

Table 19. LCD Direct Drive AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID159	F _{LCD}	LCD frame rate	10	50	150	Hz	

Table 20. Fixed UART DC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID160	I _{UART1}	Block current consumption at 100 Kbits/sec	–	–	55	μA	
SID161	I _{UART2}	Block current consumption at 1000 Kbits/sec	–	–	312	μA	

Table 21. Fixed UART AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID162	F _{UART}	Bit rate	–	–	1	Mbps	

SPI Specifications

Table 22. Fixed SPI DC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID163	I _{SPI1}	Block current consumption at 1 Mb/s/sec	–	–	360	μA	
SID164	I _{SPI2}	Block current consumption at 4 Mb/s/sec	–	–	560	μA	
SID165	I _{SPI3}	Block current consumption at 8 Mb/s/sec	–	–	600	μA	

Table 23. Fixed SPI AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID166	F _{SPI}	SPI operating frequency (master; 6X oversampling)	–	–	8	MHz	

Table 24. Fixed SPI Master mode AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID167	T _{DMO}	MOSI valid after Scklock driving edge	–	–	15	ns	
SID168	T _{DSI}	MISO valid before Scklock capturing edge. Full clock, late MISO Sampling used	20	–	–	ns	
SID169	T _{HMO}	Previous MOSI data hold time with respect to capturing edge at Slave	0	–	–	ns	

Table 25. Fixed SPI Slave mode AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID170	T _{DMI}	MOSI valid before Scklock capturing edge	40	–	–	ns	
SID171	T _{DSO}	MISO valid after Scklock driving edge	–	–	42 + 3 × (1/FCPU)	ns	
SID171A	T _{DSO_ext}	MISO valid after Scklock driving edge in Ext. Clock mode	–	–	48	ns	
SID172	T _{HSO}	Previous MISO data hold time	0	–	–	ns	
SID172A	T _{SSELSCK}	SSEL Valid to first SCK Valid edge	100	–	–	ns	

Memory

Table 26. Flash DC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID173	V _{PE}	Erase and program voltage	1.71	–	5.5	V	

Table 27. Flash AC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID174	T _{ROWWRITE}	Row (block) write time (erase and program)	–	–	20	ms	Row (block) = 128 bytes
SID175	T _{ROWERASE}	Row erase time	–	–	13	ms	
SID176	T _{ROWPROGRAM}	Row program time after erase	–	–	7	ms	
SID178	T _{BULKERASE}	Bulk erase time (128 KB)	–	–	35	ms	
SID179	T _{SECTORERASE}	Sector erase time (8 KB)	–	–	15	ms	
SID180	T _{DEVPROG}	Total device program time	–	–	15	seconds	Guaranteed by characterization
SID181	F _{END}	Flash endurance	100 K	–	–	cycles	Guaranteed by characterization
SID182	F _{RET}	Flash retention. T _A ≤ 55 °C, 100 K P/E cycles	20	–	–	years	Guaranteed by characterization
SID182A		Flash retention. T _A ≤ 85 °C, 10 K P/E cycles	10	–	–	years	Guaranteed by characterization
SID182B	F _{RETQ}	Flash retention. T _A ≤ 105 °C, 10K P/E cycles, ≤ three years at T _A ≥ 85 °C	10	20	–	years	Guaranteed by characterization.

System Resources

Power-on-Reset (POR) with Brown Out

Table 28. Imprecise Power On Reset (PRES)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID185	V _{RISEIPOR}	Rising trip voltage	0.80	–	1.45	V	Guaranteed by characterization
SID186	V _{FALLIPOR}	Falling trip voltage	0.75	–	1.4	V	Guaranteed by characterization
SID187	V _{IPORHYST}	Hysteresis	15	–	200	mV	Guaranteed by characterization

Table 29. Precise Power On Reset (POR)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID190	V _{FALLPPOR}	BOD trip voltage in active and sleep modes	1.64	–	–	V	Guaranteed by characterization
SID192	V _{FALLDPSLP}	BOD trip voltage in Deep Sleep	1.4	–	–	V	Guaranteed by characterization

Voltage Monitors

Table 30. Voltage Monitors DC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID195	V _{LVI1}	LVI_A/D_SEL[3:0] = 0000b	1.71	1.75	1.79	V	
SID196	V _{LVI2}	LVI_A/D_SEL[3:0] = 0001b	1.76	1.80	1.85	V	
SID197	V _{LVI3}	LVI_A/D_SEL[3:0] = 0010b	1.85	1.90	1.95	V	
SID198	V _{LVI4}	LVI_A/D_SEL[3:0] = 0011b	1.95	2.00	2.05	V	
SID199	V _{LVI5}	LVI_A/D_SEL[3:0] = 0100b	2.05	2.10	2.15	V	
SID200	V _{LVI6}	LVI_A/D_SEL[3:0] = 0101b	2.15	2.20	2.26	V	
SID201	V _{LVI7}	LVI_A/D_SEL[3:0] = 0110b	2.24	2.30	2.36	V	
SID202	V _{LVI8}	LVI_A/D_SEL[3:0] = 0111b	2.34	2.40	2.46	V	
SID203	V _{LVI9}	LVI_A/D_SEL[3:0] = 1000b	2.44	2.50	2.56	V	
SID204	V _{LVI10}	LVI_A/D_SEL[3:0] = 1001b	2.54	2.60	2.67	V	
SID205	V _{LVI11}	LVI_A/D_SEL[3:0] = 1010b	2.63	2.70	2.77	V	
SID206	V _{LVI12}	LVI_A/D_SEL[3:0] = 1011b	2.73	2.80	2.87	V	
SID207	V _{LVI13}	LVI_A/D_SEL[3:0] = 1100b	2.83	2.90	2.97	V	
SID208	V _{LVI14}	LVI_A/D_SEL[3:0] = 1101b	2.93	3.00	3.08	V	
SID209	V _{LVI15}	LVI_A/D_SEL[3:0] = 1110b	3.12	3.20	3.28	V	
SID210	V _{LVI16}	LVI_A/D_SEL[3:0] = 1111b	4.39	4.50	4.61	V	
SID211	LVI_IDD	Block current	–	–	100	μA	Guaranteed by characterization

Table 31. Voltage Monitors AC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID212	T _{MONTRIP}	Voltage monitor trip time	–	–	1	μs	Guaranteed by characterization

SWD Interface

Table 32. SWD Interface Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID213	F_SWCLK1	$3.3\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	–	–	14	MHz	SWDCLK $\leq$ 1/3 CPU clock frequency
SID214	F_SWCLK2	$1.71\text{ V} \leq V_{DD} \leq 3.3\text{ V}$	–	–	7	MHz	SWDCLK $\leq$ 1/3 CPU clock frequency
SID215	T_SWDI_SETUP	$T = 1/f_{\text{SWDCLK}}$	0.25*T	–	–	ns	Guaranteed by characterization
SID216	T_SWDI_HOLD	$T = 1/f_{\text{SWDCLK}}$	0.25*T	–	–	ns	Guaranteed by characterization
SID217	T_SWDO_VALID	$T = 1/f_{\text{SWDCLK}}$	–	–	0.5*T	ns	Guaranteed by characterization
SID217A	T_SWDO_HOLD	$T = 1/f_{\text{SWDCLK}}$	1	–	–	ns	Guaranteed by characterization

Internal Main Oscillator

Table 33. IMO DC Specifications

(Guaranteed by Design)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID218	I_IMO1	IMO operating current at 48 MHz	–	–	1000	μA	
SID219	I_IMO2	IMO operating current at 24 MHz	–	–	325	μA	
SID220	I_IMO3	IMO operating current at 12 MHz	–	–	225	μA	
SID221	I_IMO4	IMO operating current at 6 MHz	–	–	180	μA	
SID222	I_IMO5	IMO operating current at 3 MHz	–	–	150	μA	

Table 34. IMO AC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID223	F_IMOTOL1	Frequency variation from 3 to 48 MHz	–	–	±2	%	±3% if $T_A > 85^\circ\text{C}$ and IMO frequency < 24 MHz
SID226	T_STARTIMO	IMO startup time	–	–	12	μs	
SID227	T_JITRMSIMO1	RMS Jitter at 3 MHz	–	156	–	ps	
SID228	T_JITRMSIMO2	RMS Jitter at 24 MHz	–	145	–	ps	
SID229	T_JITRMSIMO3	RMS Jitter at 48 MHz	–	139	–	ps	

Internal Low-Speed Oscillator

Table 35. ILO DC Specifications

(Guaranteed by Design)

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID231	I_ILO1	ILO operating current at 32 kHz	–	0.3	1.05	μA	Guaranteed by Characterization
SID233	I_ILOLEAK	ILO leakage current	–	2	15	nA	Guaranteed by Design

Table 36. ILO AC Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID234	T _{STARTILO1}	ILO startup time	–	–	2	ms	Guaranteed by characterization
SID236	T _{ILODUTY}	ILO duty cycle	40	50	60	%	Guaranteed by characterization
SID237	F _{ILOTRIM1}	32 kHz trimmed frequency	15	32	50	kHz	Max ILO frequency is 70 kHz if T _A > 85 °C

Table 37. External Clock Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID305	ExtClkFreq	External Clock input Frequency	0	–	48	MHz	Guaranteed by characterization
SID306	ExtClkDuty	Duty cycle; Measured at V _{DD/2}	45	–	55	%	Guaranteed by characterization

Table 38. Watch Crystal Oscillator (WCO) Specifications

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details / Conditions
IMO WCO-PLL calibrated mode							
SID330	IMO _{WCO1}	Frequency variation with IMO set to 3 MHz	–0.6	–	0.6	%	Does not include WCO tolerance
SID331	IMO _{WCO2}	Frequency variation with IMO set to 5 MHz	–0.4	–	0.4	%	Does not include WCO tolerance
SID332	IMO _{WCO3}	Frequency variation with IMO set to 7 MHz or 9 MHz	–0.3	–	0.3	%	Does not include WCO tolerance
SID333	IMO _{WCO4}	All other IMO frequency settings	–0.2	–	0.2	%	Does not include WCO tolerance
WCO Specifications							
SID398	F _{WCO}	Crystal frequency	–	32.768		kHz	
SID399	F _{TOL}	Frequency tolerance	–	50	250	ppm	With 20-ppm crystal.
SID400	ESR	Equivalent series resistance	–	50	–	kΩ	
SID401	PD	Drive level	–	–	1	μW	
SID402	T _{START}	Startup time	–	–	500	ms	
SID403	C _L	Crystal load capacitance	6	–	12.5	pF	
SID404	C ₀	Crystal shunt capacitance	–	1.35	–	pF	
SID405	I _{WCO1}	Operating current (high power mode)	–	–	8	uA	

Table 39. Block Specs

Spec ID	Parameter	Description	Min	Typ	Max	Units	Details/Conditions
SID257	T _{WS24} *	Number of wait states at 24 MHz	1	–	–		CPU execution from Flash
SID260	V _{REFSAR}	Trimmed internal reference to SAR	–1	–	+1	%	Percentage of V _{bg} (1.024 V). Guaranteed by characterization
SID261	F _{SARINTREF}	SAR operating speed without external reference bypass	–	–	100	ksps	12-bit resolution. Guaranteed by characterization
SID262	T _{CLKSWITCH}	Clock switching from clk1 to clk2 in clk1 periods	3	–	4	Periods	Guaranteed by design

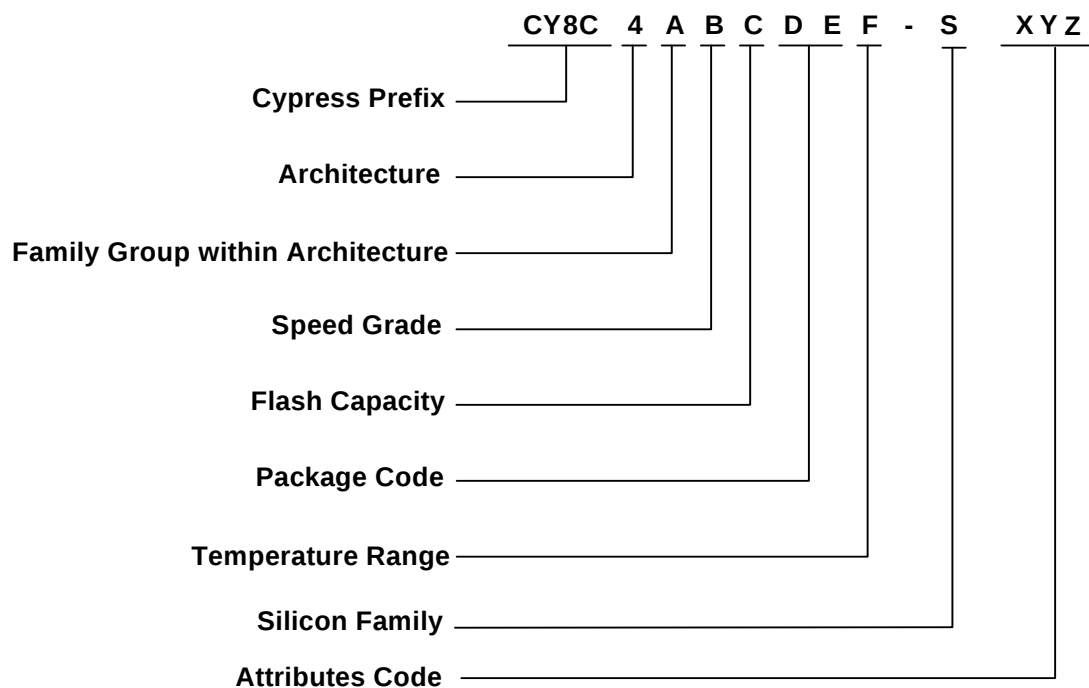
* T_{WS24} is guaranteed by design

The nomenclature used in the preceding table is based on the following part numbering convention:

Field	Description	Values	Meaning
CY8C	Cypress Prefix		
4	Architecture	4	PSoC 4
A	Family	1	4100 Family
B	CPU Speed	4	48 MHz
C	Flash Capacity	4	16 KB
		5	32 KB
		6	64 KB
		7	128 KB
DE	Package Code	AX, AZ	TQFP
		LQ	QFN
		BU	BGA
		FD	CSP
F	Temperature Range	I	Industrial
		Q	Extended Industrial
S	Silicon Family	N/A	PSoC 4 Base Series
		L	PSoC 4 L-Series
		BL	PSoC 4 BLE
		M	PSoC 4 M-Series
XYZ	Attributes Code	000-999	Code of feature set in the specific family

Part Numbering Conventions

The part number fields are defined as follows.



Packaging

The description of the PSoC4100M package dimensions follows.

Spec ID#	Package	Description	Package Dwg #
PKG_1	68-pin QFN	68 QFN, 8 mm x 8 mm x 1.0 mm height with 0.4 mm pitch	001-09618
PKG_2	64-pin TQFP	64 TQFP, 10 mm x10 mm x 1.4 mm height with 0.5 mm pitch	51-85051
PKG_4	64-pin TQFP	64 TQFP, 14 mm x14 mm x 1.4 mm height with 0.8 mm pitch	51-85046
PKG_5	48-pin TQFP	48 TQFP, 7 mm x 7 mm x 1.4 mm height with 0.5 mm pitch	51-85135
PKG_6	44-pin TQFP	44 TQFP, 10 mm x 10 mm x 1.4 mm height with 0.8 mm pitch	51-85064

Table 40. Package Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Units
T _A	Operating ambient temperature		–40	25	85	°C
T _J	Operating junction temperature		–40	–	100	°C
T _{JA}	Package θ_{JA} (68-pin QFN)		–	16.8	–	°C/Watt
T _{JC}	Package θ_{JC} (68-pin QFN)		–	2.9	–	°C/Watt
T _{JA}	Package θ_{JA} (64-pin TQFP, 0.5-mm pitch)		–	56	–	°C/Watt
T _{JC}	Package θ_{JC} (64-pin TQFP, 0.5-mm pitch)		–	19.5	–	°C/Watt
T _{JA}	Package θ_{JA} (64-pin TQFP, 0.8-mm pitch)		–	66.4	–	°C/Watt
T _{JC}	Package θ_{JC} (64-pin TQFP, 0.8-mm pitch)		–	18.2	–	°C/Watt
T _{JA}	Package θ_{JA} (48-pin TQFP, 0.5-mm pitch)		–	67.3	–	°C/Watt
T _{JC}	Package θ_{JC} (48-pin TQFP, 0.5-mm pitch)		–	30.4	–	°C/Watt
T _{JA}	Package θ_{JA} (44-pin TQFP, 0.8-mm pitch)		–	57	–	°C/Watt
T _{JC}	Package θ_{JC} (44-pin TQFP, 0.8-mm pitch)		–	25.9	–	°C/Watt

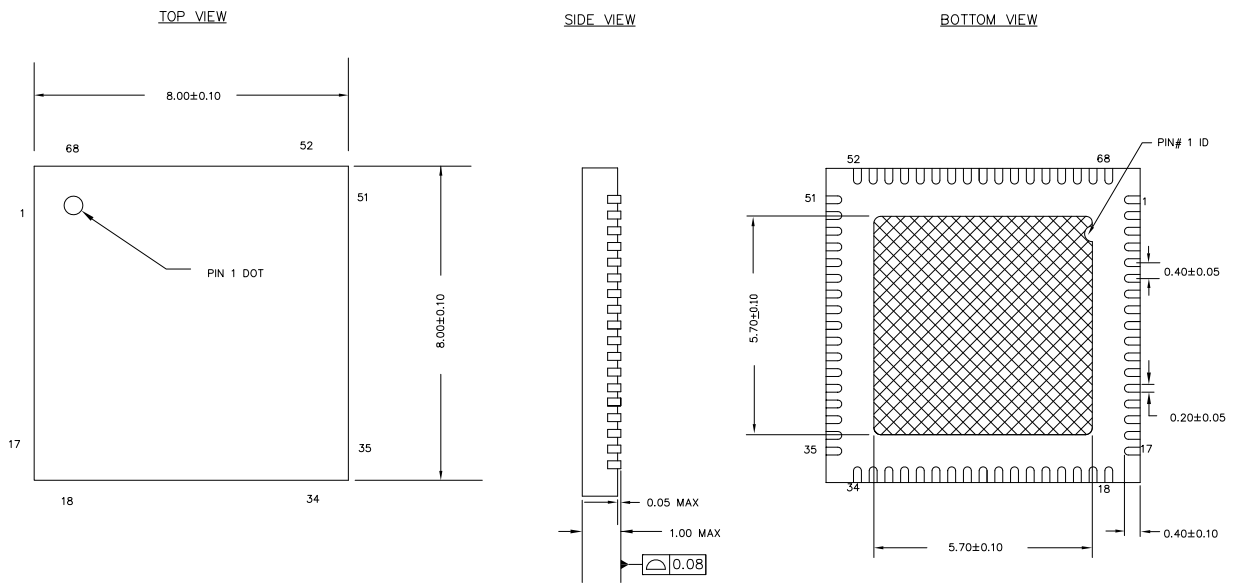
Table 41. Solder Reflow Peak Temperature

Package	Maximum Peak Temperature	Maximum Time at Peak Temperature
All packages	260 °C	30 seconds

Table 42. Package Moisture Sensitivity Level (MSL), IPC/JEDEC J-STD-2

Package	MSL
All packages	MSL 3

Figure 5. 68-Pin 8 × 8 × 1.0 mm QFN Package Outline

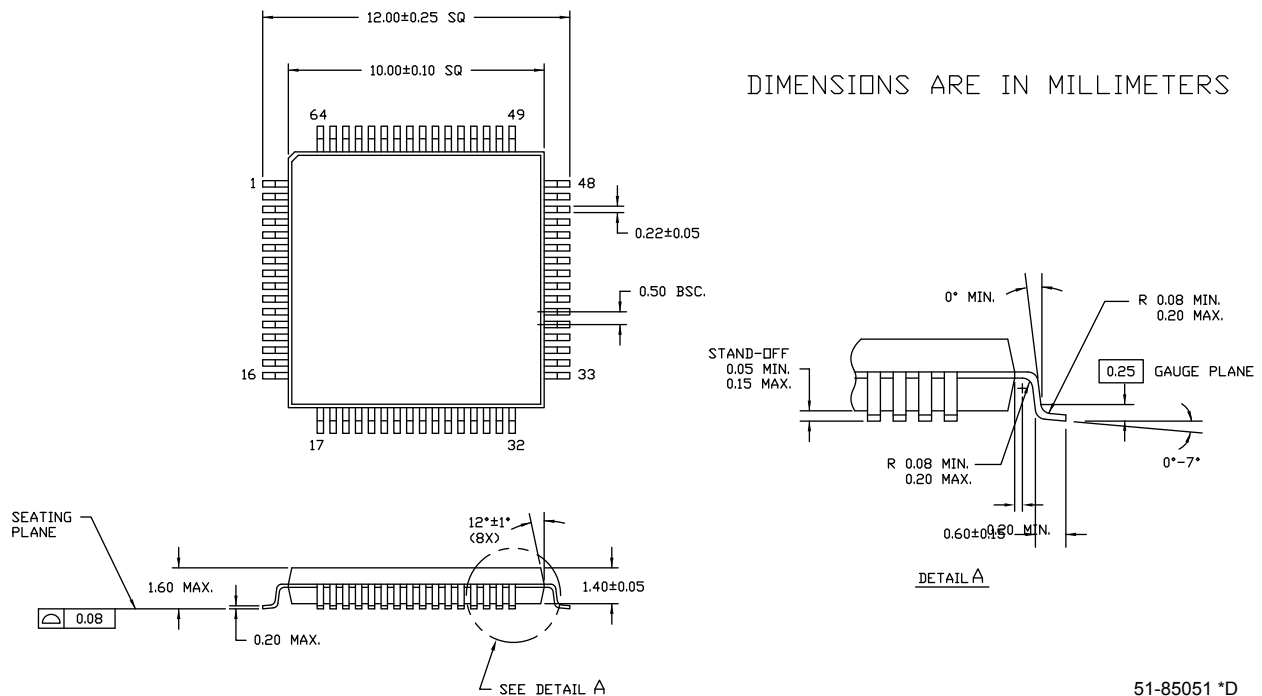


NOTES:

1.  HATCH AREA IS SOLDERABLE EXPOSED METAL.
2. REFERENCE JEDEC#: MO-220
3. PACKAGE WEIGHT: 17 ± 2mg
4. ALL DIMENSIONS ARE IN MILLIMETERS

001-09618 *E

Figure 6. 64-Pin 10 × 10 × 1.4 mm TQFP Package Outline



51-85051 *D

Figure 7. 64-Pin 14 × 14 × 1.4 mm TQFP Package Outline

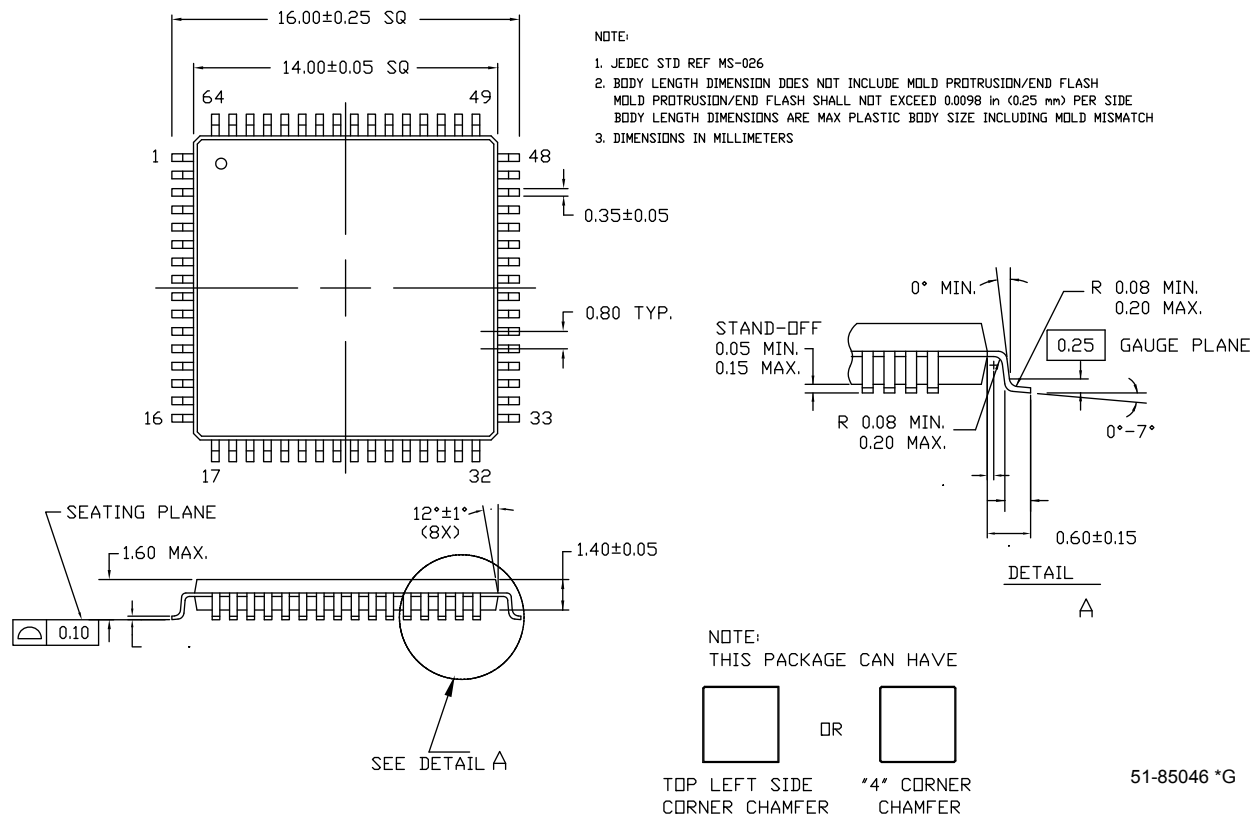


Figure 8. 48-Pin 7 × 7 × 1.4 mm TQFP Package Outline

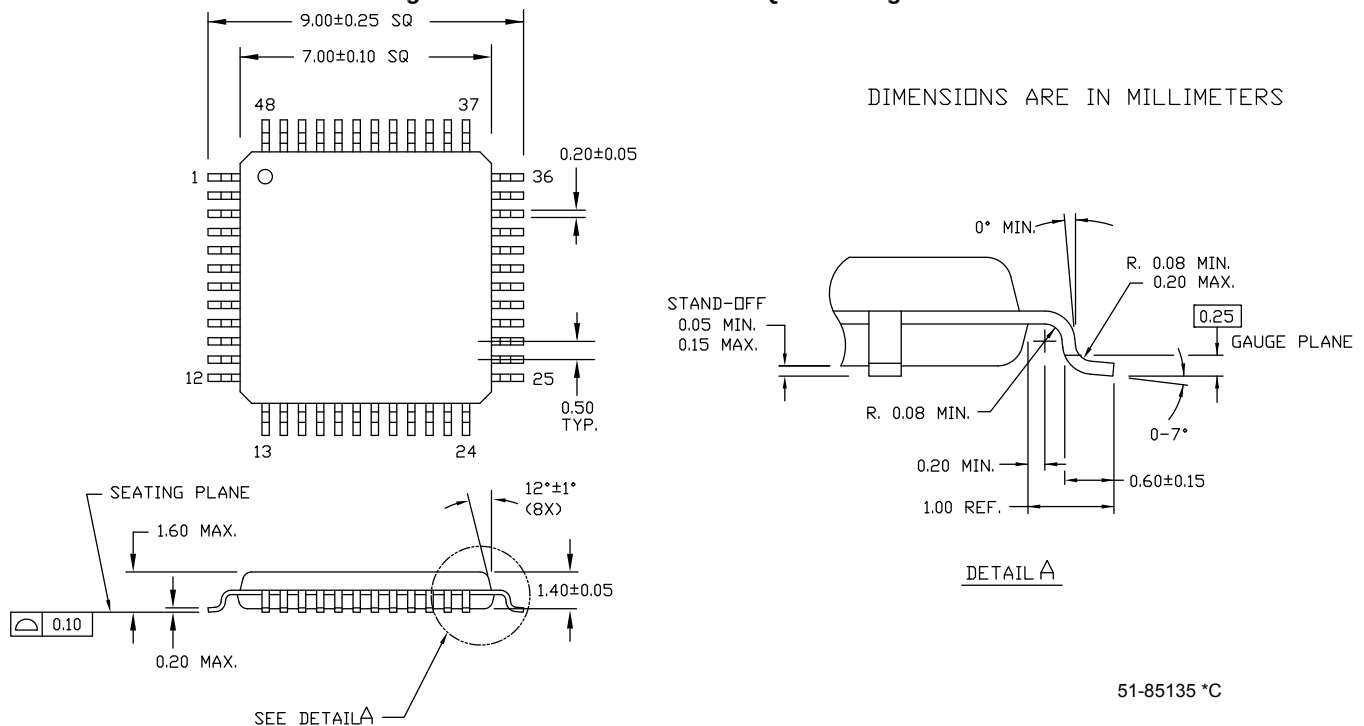
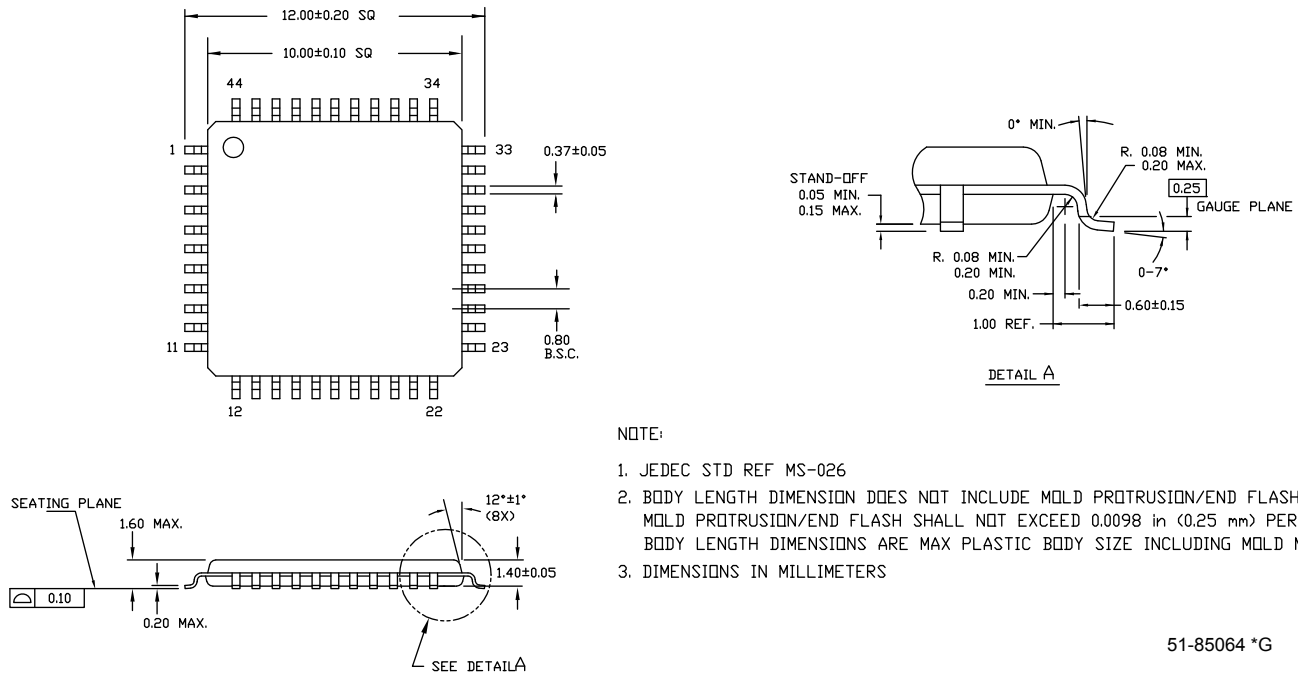


Figure 9. 44-Pin 10 × 10 × 1.4 mm TQFP Package Outline



51-85064 *G

Table 43. Acronyms Used in this Document *(continued)*

Acronym	Description
PGA	programmable gain amplifier
PHUB	peripheral hub
PHY	physical layer
PICU	port interrupt control unit
PLA	programmable logic array
PLD	programmable logic device, see also PAL
PLL	phase-locked loop
PMDD	package material declaration data sheet
POR	power-on reset
PRES	precise power-on reset
PRS	pseudo random sequence
PS	port read data register
PSoC®	Programmable System-on-Chip™
PSRR	power supply rejection ratio
PWM	pulse-width modulator
RAM	random-access memory
RISC	reduced-instruction-set computing
RMS	root-mean-square
RTC	real-time clock
RTL	register transfer language
RTR	remote transmission request
RX	receive
SAR	successive approximation register
SC/CT	switched capacitor/continuous time
SCL	I ² C serial clock
SDA	I ² C serial data
S/H	sample and hold
SINAD	signal to noise and distortion ratio
SIO	special input/output, GPIO with advanced features. See GPIO.
SOC	start of conversion
SOF	start of frame
SPI	Serial Peripheral Interface, a communications protocol
SR	slew rate
SRAM	static random access memory
SRES	software reset
SWD	serial wire debug, a test protocol
SWV	single-wire viewer
TD	transaction descriptor, see also DMA

Table 43. Acronyms Used in this Document *(continued)*

Acronym	Description
THD	total harmonic distortion
TIA	transimpedance amplifier
TRM	technical reference manual
TTL	transistor-transistor logic
TX	transmit
UART	Universal Asynchronous Transmitter Receiver, a communications protocol
UDB	universal digital block
USB	Universal Serial Bus
USBIO	USB input/output, PSoC pins used to connect to a USB port
VDAC	voltage DAC, see also DAC, IDAC
WDT	watchdog timer
WOL	write once latch, see also NVL
WRES	watchdog timer reset
XRES	external reset I/O pin
XTAL	crystal

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